



12500 TI Boulevard, MS 8640, Dallas, Texas 75243

**Notification# 20160628009
Datasheet for LMV7219
Information Only**

Date: 7/1/2016
To: TOKYO ELECTRON DEVICE (DSTR) PCN

Dear Customer:

This is an information-only announcement of a change to a device that is currently offered by Texas Instruments.

The changes discussed within this notification are for your information only.

Any negotiated alternative change requirements will be provided via the customer's defined process. Customers with previously negotiated, special requirements will be handled separately. Any inquiries should be directed to your local Field Sales Representative.

For questions regarding this notice, contact your local Field Sales Representative or the PCN Manager (PCN_ww_admin_team@list.ti.com).

Sincerely,

PCN Team
SC Business Services

**Information Only
Attachments**

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

DEVICE	CUSTOMER PART NUMBER
LMV7219M5/NOPB	null
LMV7219M7/NOPB	null

Technical details of this Product Change follow on the next page(s).

PCN Number:	20160628009	PCN Date:	7/1/2016
Title:	Datasheet for LMV7219		
Customer Contact:	PCN Manager	Dept:	Quality Services
Change Type:			
<input type="checkbox"/> Assembly Site	<input type="checkbox"/> Design	<input type="checkbox"/> Wafer Bump Site	
<input type="checkbox"/> Assembly Process	<input checked="" type="checkbox"/> Data Sheet	<input type="checkbox"/> Wafer Bump Material	
<input type="checkbox"/> Assembly Materials	<input type="checkbox"/> Part number change	<input type="checkbox"/> Wafer Bump Process	
<input type="checkbox"/> Mechanical Specification	<input type="checkbox"/> Test Site	<input type="checkbox"/> Wafer Fab Site	
<input type="checkbox"/> Packing/Shipping/Labeling	<input type="checkbox"/> Test Process	<input type="checkbox"/> Wafer Fab Materials	
		<input type="checkbox"/> Wafer Fab Process	

Notification Details

Description of Change:

Texas Instruments Incorporated is announcing an information only notification.

The product datasheet(s) is being updated as summarized below.

The following change history provides further details.



LMV7219

SNOS458I – APRIL 2000 – REVISED JUNE 2016

Changes from Revision H (April 2016) to Revision I	Page
• Added Supports 105°C PCB Temperature to Features List.....	1
• Changed Operating Temperature to Ambient Temperature	4
• Added Junction Temperature of 125 °C	4
• Added PCB Temperature of 105 °C	4
• Added T _{PCB} ≤ 105°C throughout Electrical Tables	5

The datasheet number will be changing.

Device Family	Change From:	Change To:
LMV7219	SNOS458H	SNOS458I

These changes may be reviewed at the datasheet links provided.

<http://www.ti.com/product/LMV7219>

Reason for Change:

To more accurately reflect device characteristics.

Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.

Changes to product identification resulting from this PCN:

None.

Product Affected:

LMV7219M5	LMV7219M5X	LMV7219M7	LMV7219M7X
LMV7219M5/NOPB	LMV7219M5X/NOPB	LMV7219M7/NOPB	LMV7219M7X/NOPB

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com